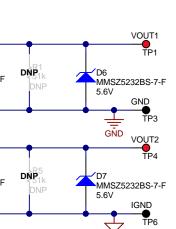
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3	TP2 47µH 47µH C3 10µF GND TP5	Image: Product of the second secon
В	TP5	GND 22.0M D5 R6 BAV21WS-7-F S1 S1 S1 S1 S1 S1 S1 S1 S1 S1
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D	PCB F	Number: PMP20583 PCB Rev: A PCB LOGO FCC disclaimer           Orderable: N/A       Designed for: Public Release       Mod. Date: 12/2/2017         TID#: PMP20583       Project Title: UCC28700-Q1 Dual Output Flyback       Number: PMP20583         Number: PMP20583       Rev: A       Sheet Title:       Sheet Title:         S do not warrant the accuracy or completeness of this specification or any information contained therein. Texas Instruments and/or its licensors do not       SNRev: Version control disabed       Assembly Variant: 001       Sheet: 1 of 1
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